

### Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control

#### **Features**

• Operating frequencies: 1.4 - 2.7 GHz

• Insertion power gain: 20.2 dB

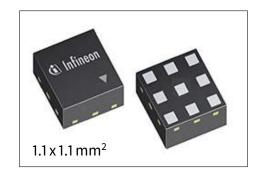
• Gain dynamic range: 23 dB

• Low noise figure: 0.6 dB

• Low current consumption: 5.8 mA

Multi-state control: Gain- and Bypass-Modes

• Small TSNP leadless package



#### **Potential Applications**

The BGA9H1MN9 is designed for 4G and 5G applications covering 3GPP Bands between 1.4 and 2.7 GHz (primarily for bands B1, B3, n41 and B21). Thanks to a high gain and an ultra-low Noise Figure performance of the LNA frontend losses can be compensated and the data rate can be significantly improved. The MIPI interface provides a comprehensive control over multiple gain steps and bias modes to increase the overall system dynamic range.

#### **Product Validation**

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

#### **Block Diagram**

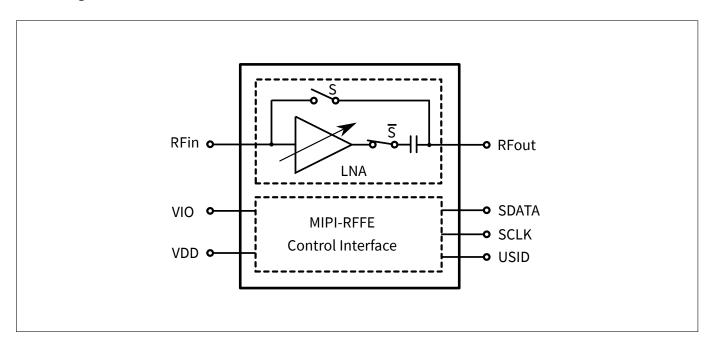






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### Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**Product Description** 

#### 1 Features

• Power gain: 20.2 dB

• Low noise figure: 0.6 dB

• Low current consumption: 5.8 mA

• Frequency range from 1.4 to 2.7 GHz

• Supply voltage: 1.1 to 2.0 V

• Integrated MIPI RFFE interface operating in 1.65 to 1.95 V voltage range

• Software programmable MIPI RFFE USID

• USID select pin

• Small form factor 1.1 mm x 1.1 mm

• High EMI robustness

RoHS and WEEE compliant package





### 2 Product Description

The BGA9H1MN9 is a low noise amplifier for LTE and 5G which covers a wide frequency range from 1.4 GHz to 2.7 GHz. The LNA provides up to 20.2 dB gain and 0.6 dB noise figure at a current consumption of 5.8 mA in the application configuration described in Chapter 7. With the Gain Step feature the gain and linearity can be adjusted to increase the system dynamic range and to accommodate to changing interference scenarios. The BGA9H1MN9 supports ultra-low bypass current of 2  $\mu$ A and 1.2 V operating voltage to reduce power consumption. It operates from 1.1 V to 2.0 V supply voltage over temperature. The compact 9 pin TSNP-9 package with the dimension of 1.1 x 1.1 mm helps to save space on the PCB.

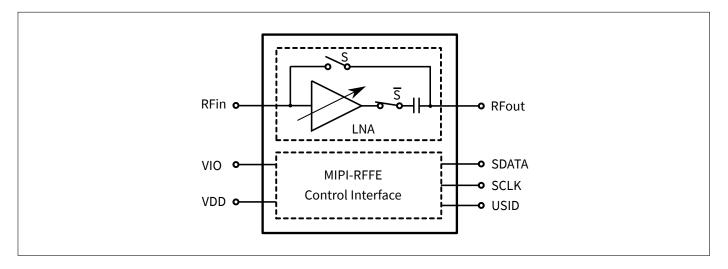


Figure 1: BGA9H1MN9 Block diagram

Product Name	Marking	Package
BGA9H1MN9	Н	TSNP-9-2

### Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**Maximum Ratings** 

## 3 Maximum Ratings

**Table 1: Maximum Ratings** 

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
Supply Voltage VDD	$V_{DD}$	-0.5	_	2.2	٧	1
Voltage at RFin	V <sub>AI</sub>	0	_	0	٧	-
Voltage at RFout	V <sub>AO</sub>	0	_	0	٧	-
Current into pin VDD	I <sub>DD</sub>	-	_	30	mA	-
RF input power	P <sub>IN</sub>	-	_	25	dBm	-
Total power dissipation	P <sub>tot</sub>	-	_	70	mW	
Junction temperature	TJ	-	_	150	°C	-
Ambient temperature range	T <sub>A</sub>	-30	_	85	°C	-
Storage temperature range	$T_{STG}$	-55	_	150	°C	-
ESD robustness, HBM	V <sub>ESD_HBM</sub>	-1000	_	1000	٧	2
ESD robustness, CDM	V <sub>ESD_CDM</sub>	-1000	_	1000	٧	3
RFFE Supply Voltage	V <sub>IO</sub>	-0.5	_	2.2	٧	-
RFFE Supply Voltage Levels	V <sub>SCLK</sub> ,	-0.7	_	V <sub>10</sub> + 0.7	٧	_
NEFT Supply Vollage Levels	$V_{\rm SDATA}$ ,			(max. 2.2)		
	$V_{\rm USID}$					

<sup>&</sup>lt;sup>1</sup>All voltages refer to GND-Nodes unless otherwise noted

Attention: Stresses above the max. values listed here may cause permanent damage to the device. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Exposure to conditions at or below absolute maximum rating but above the specified maximum operation conditions may affect device reliability and life time. Functionality of the device might not be given under these conditions.

<sup>&</sup>lt;sup>2</sup>Human Body Model ANSI/ESDA/JEDEC JS-001 ( $R = 1.5 \text{ k}\Omega$ , C = 100 pF).

<sup>&</sup>lt;sup>3</sup>Field-Induced Charged-Device Model ANSI/ESDA/JEDEC JS-002. Simulates charging/discharging events that occur in production equipment and processes. Potential for CDM ESD events occurs whenever there is metal-to-metal contact in manufacturing.

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**RF Characteristics** 

### **4 DC Characteristics**

Table 3: DC Characteristics at  $T_{\rm A}$  = 25  $^{\circ}$ C

Parameter <sup>1</sup>	Symbol Values				Unit	Note / Test Condition
		Min.	Тур.	Max.		
Supply Voltage	$V_{\mathrm{DD}}$	1.1	1.8	2.0	V	-
Supply Current	,	4.3	5.8	7.3	mA	G0/G1 mode in Bias6
Supply Current	l l <sub>DD</sub>	2.7	3.7	4.7	mA	G2-G5 mode in Bias2
		-	2	4	μΑ	Bypass mode (all bias)
RFFE supply voltage	V <sub>IO</sub>	1.65	1.8	1.95	V	-
RFFE input high voltage <sup>2</sup>	V <sub>IH</sub>	0.7 * V <sub>IO</sub>	-	V <sub>IO</sub>	V	Logical "1"
RFFE input low voltage <sup>2</sup>	V <sub>IL</sub>	0	_	0.3 * V <sub>IO</sub>	V	Logical "0"
RFFE output high voltage <sup>3</sup>	V <sub>OH</sub>	0.8 * V <sub>IO</sub>	_	V <sub>IO</sub>	V	-
RFFE output low voltage <sup>3</sup>	V <sub>OL</sub>	0	_	0.2 * V <sub>IO</sub>	V	-
RFFE control input capacitance	C <sub>Ctrl</sub>	-	_	2	pF	-
RFFE supply current	I <sub>VIO</sub>	_	3	_	μΑ	Idle State

<sup>&</sup>lt;sup>1</sup>Based on the application described in Chapter 7

# **5 RF Characteristics**

Table 4: RF Characteristics in ON Mode at  $T_A$  = 25 °C,  $V_{DD}$  = 1.8 V, f = 1.4 – 1.5 GHz, performance guaranteed in bias modes as in Table 3

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
		18.2	19.7	21.2	dB	G0
		14.0	15.5	17.0	dB	G1
Incortion nower gain		13.4	14.9	16.4	dB	G2
Insertion power gain  f = 1450 MHz	$1/ S_{21} ^2$	9.3	10.8	12.3	dB	G3
7 – 1430 MITZ		4.9	6.4	7.9	dB	G4
		-4.8	-3.3	-1.8	dB	G5
		-6.8	-5.8	-4.8	dB	G6
		-	0.65	1.2	dB	G0
		-	0.7	1.3	dB	G1
Noice Figure		-	0.85	1.4	dB	G2
Noise Figure <i>f</i> = 1450 MHz	NF	_	1.05	1.6	dB	G3
I — 1430 МПZ		-	1.55	2.1	dB	G4
		-	11.5	12.5	dB	G5
		_	5.8	6.8	dB	G6

<sup>&</sup>lt;sup>2</sup>SCLK, SDATA and USID

<sup>&</sup>lt;sup>3</sup>SDATA

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**RF Characteristics** 

Table 4: RF Characteristics - Continued from previous page

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Тур.	Max.		
		6	9	_	dB	G0
		5	8	_	dB	G1
		10	15	_	dB	G2
Input Return Loss <sup>1</sup>	RL <sub>in</sub>	9	13	_	dB	G3
f = 1450 MHz		9	13	_	dB	G4
		7	11	_	dB	G5
		2	3	_	dB	G6
		10	15	_	dB	G0
		9	13	_	dB	G1
0.1.15.1.1		10	15	_	dB	G2
Output Return Loss	RLout	8	12	_	dB	G3
f = 1450 MHz		4	7	_	dB	G4
		9	13	-	dB	G5
		2	3	_	dB	G6
		34	39	_	dB	G0
		38	43	_	dB	G1
		31	36	_	dB	G2
Reverse Isolation	$1/ S_{12} ^2$	35	40	_	dB	G3
f = 1450 MHz		39	44	_	dB	G4
		35	40	_	dB	G5
		4.8	5.8	_	dB	G6
		-21	-17	_	dBm	G0
		-20	-16	_	dBm	G1
Inband input 1dB-compression		-18	-14	_	dBm	G2
point	IP <sub>1dB</sub>	-17	-13	_	dBm	G3
f = 1450 MHz		-17	-13	_	dBm	G4
		-6	-2	_	dBm	G5
		+4	+8	_	dBm	G6
		-15	-11	_	dBm	G0
		-15	-11	_	dBm	G1
		-15	-9	_	dBm	G2
Inband input 3 <sup>rd</sup> -order intercept	IIP3	-13	-9	_	dBm	G3
point <sup>2</sup>		-15	-9	_	dBm	G4
		0	+5	_	dBm	G5
		+12	+17	_	dBm	G6
Phase discontinuity between all		-20	_	20	0	Part to part variation after com-
Gain Mode combinations						pensation in Base Band with
<i>f</i> = 1450 MHz						constant value

<sup>&</sup>lt;sup>1</sup>Can be tuned by using additional external matching components

<sup>&</sup>lt;sup>2</sup>Input power = -30 dBm for each tone for modes G0-G5 / -15 dBm for mode G6,  $f_1$  = 1450 MHz,  $f_2$  =  $f_1$  + 1 MHz

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**RF Characteristics** 

Table 4: RF Characteristics - Continued from previous page

Parameter	Symbol Values		Symbol Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
Stability	k	>1	-	_		f = 20 MHz - 10 GHz
MIPI to RF time	t <sub>PUP</sub>	_	-	1	μs	50 % last SCLK falling edge to 90 % ON, see Fig. 2

Table 5: RF Characteristics in ON Mode at  $T_{\rm A}$  = 25 °C,  $V_{\rm DD}$  = 1.8 V, f = 1.8 – 2.2 GHz, performance guaranteed in bias modes as in Table 3

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
		18.7	20.2	21.7	dB	G0
		16.2	17.7	19.2	dB	G1
Insertion power gain		13.1	14.6	16.1	dB	G2
<i>f</i> = 2100 MHz	$ 1/ S_{21} ^2$	10.6	12.1	13.6	dB	G3
7 - 2100 WITIZ		7.5	9.0	10.5	dB	G4
		-2.7	-1.2	0.3	dB	G5
		-3.7	-2.7	-1.7	dB	G6
	NF	_	0.6	1.2	dB	G0
		-	0.65	1.2	dB	G1
Noise Figure		_	0.9	1.5	dB	G2
f = 2100 MHz		_	1.0	1.6	dB	G3
7 - 2100 WITE		-	1.2	1.8	dB	G4
		_	10.4	11.4	dB	G5
		_	2.7	3.7	dB	G6
		6	9	_	dB	G0
		6	9	_	dB	G1
Input Return Loss <sup>1</sup>		9	13	_	dB	G2
f = 2100 MHz	RL <sub>in</sub>	9	13	_	dB	G3
7 - 2100 WILIZ		9	13	_	dB	G4
		10	18	_	dB	G5
		5	8	_	dB	G6

<sup>&</sup>lt;sup>1</sup>Can be tuned by using additional external matching components

# Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**RF Characteristics** 

Table 5: RF Characteristics - Continued from previous page

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
		10	14	_	dB	G0
		10	19	_	dB	G1
Output Deturn Less		10	16	_	dB	G2
Output Return Loss	RLout	10	19	_	dB	G3
f = 2100 MHz		10	17	_	dB	G4
		9	13	_	dB	G5
		4	7	_	dB	G6
		34	39	_	dB	G0
		35	40	_	dB	G1
Deverse lealeties		29	34	_	dB	G2
Reverse Isolation	$1/ S_{12} ^2$	30	35	_	dB	G3
f = 2100 MHz		33	38	_	dB	G4
		30	35	_	dB	G5
		1.7	2.7	_	dB	G6
		-20	-16	_	dBm	G0
		-19	-15	_	dBm	G1
Inband input 1dB-compression	IP <sub>1dB</sub>	-16	-12	_	dBm	G2
point		-16	-12	_	dBm	G3
f = 2100 MHz		-16	-12	_	dBm	G4
		-5	-1	_	dBm	G5
		+3	+7	_	dBm	G6
		-10	-6	_	dBm	G0
		-10	-6	_	dBm	G1
Inband input 3 <sup>rd</sup> -order intercept		-8	-4	_	dBm	G2
	IIP3	-8	-4	_	dBm	G3
point <sup>1</sup>		-8	-4	_	dBm	G4
		+3	+8	_	dBm	G5
		+18	+23	_	dBm	G6
Phase discontinuity between all Gain Mode combinations $f = 2100  \text{MHz}$		-20	-	20	0	Part to part variation after com- pensation in Base Band with constant value
Stability	k	>1	_	_		f = 20 MHz - 10 GHz
MIPI to RF time	$t_{PUP}$	-	_	1	μs	50 % last SCLK falling edge to 90 % ON, see Fig. 2

 $<sup>^{1}</sup>$ Input power = -30 dBm for each tone for modes G0-G5 / -15 dBm for mode G6,  $f_{1}$  = 2100 MHz,  $f_{2}$  =  $f_{1}$  + 1 MHz

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**RF Characteristics** 

Table 6: RF Characteristics in ON Mode at  $T_{\rm A}$  = 25 °C,  $V_{\rm DD}$  = 1.8 V, f = 2.3 – 2.7 GHz, performance guaranteed in bias modes as in Table 3

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
		17.5	19.0	20.5	dB	G0
		15.0	16.5	18.0	dB	G1
		11.6	13.1	14.6	dB	G2
Insertion power gain	$1/ S_{21} ^2$	9.1	10.6	12.1	dB	G3
f = 2600 MHz		5.9	7.4	8.9	dB	G4
		-2.9	-1.4	0.1	dB	G5
		-3.4	-2.4	-1.4	dB	G6
		_	0.65	1.2	dB	G0
		-	0.65	1.2	dB	G1
Noice Figure		_	0.95	1.5	dB	G2
Noise Figure <sup>f</sup> = 2600 MHz	NF	_	1.1	1.7	dB	G3
– ZOUU IVITZ		-	1.45	2.0	dB	G4
		_	9.9	10.9	dB	G5
		_	2.4	3.4	dB	G6
		5	8	_	dB	G0
		5	8	_	dB	G1
mout Datum Lagal		9	13	_	dB	G2
nput Return Loss <sup>1</sup> f = 2600 MHz	RLin	9	13	_	dB	G3
= 2600 MHZ		9	13	_	dB	G4
		10	14	_	dB	G5
		10	15	_	dB	G6
		7	11	-	dB	G0
		10	14	-	dB	G1
Output Datum Laga		7	11	_	dB	G2
Output Return Loss f = 2600 MHz	RL <sub>out</sub>	10	14	_	dB	G3
7 – 2600 MHZ		8	12	_	dB	G4
		8	12	_	dB	G5
		7	10	_	dB	G6
		34	39	_	dB	G0
		35	40	_	dB	G1
Dovorco Icolotica		28	33	_	dB	G2
Reverse Isolation	$1/ S_{12} ^2$	29	34	_	dB	G3
f = 2600 MHz		32	37	_	dB	G4
		28	33	_	dB	G5
		1.4	2.4	_	dB	G6

 $<sup>^{1}\</sup>mbox{Can}$  be tuned by using additional external matching components

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**RF Characteristics** 

Table 6: RF Characteristics - Continued from previous page

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
		-19	-15	_	dBm	G0
		-19	-15	_	dBm	G1
Inband input 1dB-compression		-15	-11	_	dBm	G2
point	IP <sub>1dB</sub>	-15	-11	_	dBm	G3
f = 2600 MHz		-15	-11	_	dBm	G4
		-5	-1	_	dBm	G5
		+1	+5	_	dBm	G6
		-9	-6	_	dBm	G0
		-9	-6	_	dBm	G1
Inband input 3 <sup>rd</sup> -order intercept		-7	-4	_	dBm	G2
point <sup>1</sup>	IIP3	-7	-4	_	dBm	G3
point		-7	-4	_	dBm	G4
		+5	+10	_	dBm	G5
		+15	+20	_	dBm	G6
Phase discontinuity between all		-20	_	20	0	Part to part variation after com-
Gain Mode combinations						pensation in Base Band with
f = 2600 MHz						constant value
Stability	k	>1	_	_		f = 20 MHz - 10 GHz
MIPI to RF time	$t_{PUP}$	_	_	1	μs	50% last SCLK falling edge to
mi road dine	PUP			'	μο	90 % ON, see Fig. 2

 $<sup>^{1}</sup>$ Input power = -30 dBm for each tone for modes G0-G5 / -15 dBm for mode G6,  $f_{1}$  = 2600 MHz,  $f_{2}$  =  $f_{1}$  + 1 MHz

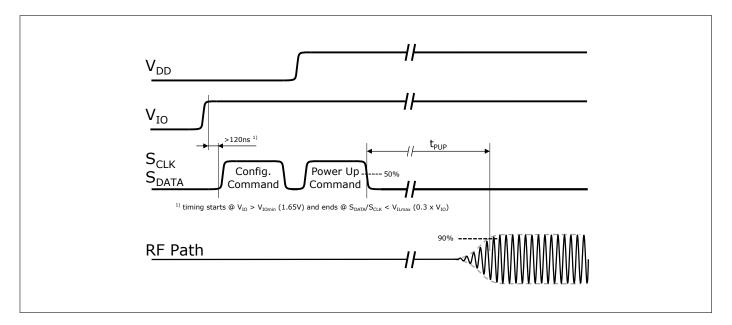


Figure 2: MIPI to RF time

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



MIPI RFFE Specification

# **6 MIPI RFFE Specification**

The MIPI RFFE interface is working in systems following the 'MIPI Alliance Specification for RF Front-End Control Interface version 2.1 - 18 December 2017' as well as the 'Qualcomm RFFE Vendor specification 80-N7876-1 Rev. W'.

#### **Table 7: MIPI Features**

Feature	Supported	Comment
MIPI RFFE 2.1 standard	Yes	Backward compatible to MIPI 2.0 standard
Register 0 write command sequence	Yes	
Register read and write command sequence	Yes	
Extended register read and write command se-	Yes	
quence		
Masked write command sequence	Yes	Indicated as MW in below register mapping tables
Support for standard frequency range operations	Yes	Up to 26 MHz for read and write
for SCLK		
Support for extended frequency range operations	Yes	Up to 52 MHz for write
for SCLK		
Half speed read	Yes	
Full speed read	Yes	
Full speed write	Yes	
Longer Reach RFFE Bus Length Feature	Yes	
Programmable driver strength	Yes	Up to 80 pF
Programmable Group SID	Yes	
Programmable USID	Yes	Support for three registers write and extended write se-
		quences
Trigger functionality	Yes	
Extended Triggers and Trigger Masks	Yes	
Broadcast / GSID write to PM TRIG register	Yes	
Reset	Yes	Via VIO, PM TRIG or software register
Status / error sum register	Yes	
Extended product ID register	Yes	
Revision ID register	Yes	
Group SID register	Yes	
USID_Sel pin	Yes	See Tab. 12
USID selection via SDATA / SCLK swap feature	Yes	See Tab. 12

### **Table 8: Startup Behavior**

Feature	re State Comment			
Power status	Low power	Lower power mode after start-up		
Trigger function	Enabled	Enabled after start-up. Programmable via behavior control register		

# Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



## MIPI RFFE Specification

### Table 9: Register Mapping, Table I

Register Address	Register Name	Data Bits	Function	Description	Default	Broadcast_ID Support	Trigger Support	R/W
0x01	REGISTER_1	7:0	MODE_CTRL	LNA control	00000000	No	Yes Trigger 0-10	R/W MW
0x1C	PM_TRIG	7	PWR_MODE(1)	0: Normal operation (ACTIVE)	1	Yes	No	R/W
			Operation Mode	1: Low Power Mode (LOW POWER)	1			MW
		6	PWR_MODE(0)	0: No action (ACTIVE)	0			
			State Bit Vector	1: Powered Reset (STARTUP to ACTIVE to LOW POWER)				
		5	TRIGGER_MASK_2	0: Data masked (held in shadow REG)	0	No		
				1: Data not masked (ready for transfer to active REG)				
		4	TRIGGER_MASK_1	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)				
		3	TRIGGER_MASK_0	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)				
		2	TRIGGER_2	0: No action (data held in shadow REG)	0	Yes		
				1: Data transferred to active REG	1			
		1	TRIGGER_1	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
		0	TRIGGER_0	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
0x1D	PRODUCT_ID	7:0	PRODUCT_ID	This is a read-only register. However, during the programming of the USID a write command sequence is performed on this register, even though the write does not change its value.	01010011	No	No	R
0x1E	MAN_ID	7:0	MANUFACTURER_ID [7:0]	This is a read-only register. However, during the programming of the USID, a write command sequence is performed on this register, even though the write does not change its value.	00011010	No	No	R
0x1F	MAN_USID	7:4	MANUFACTURER_ID [11:8]	These bits are read-only. However, during the programming of the USID, a write command sequence is performed on this register even though the write does not change its value.	0001			R
		3:0	USID[3:0]	Programmable USID. Performing a write to this register using the described programming sequences will program the USID in devices supporting this feature. These bits store the USID of the device.	See Tab. 12	No	No	R/W

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



## MIPI RFFE Specification

### Table 10: Register Mapping, Table II

Register Address	Register Name	Data Bits	Function	Description	Default	Broadcast_ID Support	Trigger Support	R/W
0x20	EXT_PRODUCT_ID	7:0	EXT_PRODUCT_ID		00000000	No	No	R
0x21	REV_ID	7:4	MAIN_REVISION		0000	No	No	R
		3:0	SUB_REVISION		0000			
0x22	GSID	7:4	GSID0[3:0]	Primary Group Slave ID.	0000	No	No	R/W
		3:0	RESERVED	Reserved for secondary Group Slave ID.	0000			
0x23	0x23 UDR_RST 7		UDR_RST	Reset all configurable non-RFFE Reserved registers to default values.  0: Normal operation  1: Software reset	0	No	No	R/W
		6:0	RESERVED	Reserved for future use	0000000			
0x24	ERR_SUM	7	RESERVED	Reserved for future use	0	No	No	R
		6	COMMAND_FRAME_PARITY_ERR	Command Sequence received with par-	0			
				ity error — discard command.				
		5	COMMAND_LENGTH_ERR	Command length error.	0			
		4	ADDRESS_FRAME_PARITY_ERR	Address frame with parity error.	0			
		3	DATA_FRAME_PARITY_ERR	Data frame with parity error.	0			
		2	READ_UNUSED_REG	Read command to an invalid address.	0			
		1	WRITE_UNUSED_REG	Write command to an invalid address.	0			
		0	BID_GID_ERR	Read command with a BROADCAST_ID or GROUP_ID.	0			
0x2B	BUS_LD	7:3	RESERVED	Reserved for future use	0x0	No	No	R/W
		2:0	BUS_LD[2:0]	Programs the drive strength of the	0x4			
				SDATA driver in readback modes.				
				0x0: 10pF				
				0x1: 20pF				
				0x2: 30pF				
				0x3: 40pF				
				0x4: 50pF (default)				
				0x5: 60pF				
				0x6: 80pF				
020	EVT TDIC MACK	7	TRICCER MACK 10	0x7: 80pF  0: Data masked (held in shadow REG)		N-	N-	D/W
0x2D	EXT_TRIG_MASK	7	TRIGGER_MASK_10	, ,	0	No	No	R/W
				1: Data not masked (ready for transfer to active REG)				MW
		6	TRIGGER_MASK_9	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)				
		5	TRIGGER_MASK_8	0: Data masked (held in shadow REG)	0			
		3	TRIOGER_MASK_0	1: Data not masked (ready for transfer to				
		_	TRICCER MACK 7	active REG)				
		4	TRIGGER_MASK_7	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)				
		3	TRIGGER_MASK_6	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)				
		2	TRIGGER_MASK_5	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)				
		1	TRIGGER_MASK_4	0: Data masked (held in shadow REG)	0			
			5021501_ !	Data masked (ready for transfer to active REG)				
		0	TRIGGER_MASK_3	0: Data masked (held in shadow REG)	0			
			osen_mon_o	1: Data not masked (ready for transfer to				
				active REG)				

# Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



## MIPI RFFE Specification

### Table 11: Register Mapping, Table III

Register	Register Name	Data	Function	Description	Default	Broadcast_ID	Trigger	R/W
Address		Bits				Support	Support	<u> </u>
0x2E	2E EXT_TRIG 7		TRIGGER_10	0: No action (data held in shadow REG)	0	Yes	No	R/W
				1: Data transferred to active REG				MW
		6	TRIGGER_9	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
		5	TRIGGER_8	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
		4 TRIGGER_7 0: No action (data held in shadow REG) 0		0				
				1: Data transferred to active REG				
		3	TRIGGER_6	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
		2	TRIGGER_5	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
		1	TRIGGER_4	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
		0	TRIGGER_3	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



MIPI RFFE Specification

**Table 12: USID States** 

USID pin	SDATA/SCLK	USID
0	Nominal	0b1000
1	Nominal	0b1001
0	Swap	0b1010
1	Swap	0b1011

Table 13: Gain Modes of Operation (Truth Table, Register\_1)

		REGISTER_1 Bits								
State	Mode	D7	D6	D5	D4	D3	D2	D1	DO	
1	OFF	0	Х	х	х	х	х	х	х	
2	Gain G0	1	0	0	1	х	х	х	х	
3	Gain G1	1	0	1	0	х	х	х	х	
4	Gain G2	1	0	1	1	х	х	х	х	
5	Gain G3	1	1	0	0	х	х	х	х	
6	Gain G4	1	1	0	1	х	х	х	х	
7	Gain G5	1	1	1	0	х	х	х	х	
8	Gain G6 (Bypass)	1	1	1	1	х	х	х	х	

Table 14: Bias settings (Truth Table, Register\_1)

		REGISTER_1 Bits									
State	Mode	D7	D6	D5	D4	D3	D2	D1	D0		
9	Bias0 (2.5 mA)	1	х	х	х	0	0	0	0		
10	Bias1 (3.1 mA)	1	х	х	х	0	0	0	1		
11	Bias2 (3.7 mA) <sup>1</sup>	1	х	х	х	0	0	1	0		
12	Bias3 (4.2 mA)	1	х	х	х	0	0	1	1		
13	Bias4 (4.7 mA)	1	х	х	х	0	1	0	0		
14	Bias5 (5.2 mA)	1	х	х	х	0	1	0	1		
15	Bias6 (5.8 mA) <sup>2</sup>	1	х	х	х	0	1	1	0		
16	Bias7 (6.3 mA)	1	Х	х	х	0	1	1	1		
17	Bias8 (6.8 mA)	1	х	х	х	1	0	0	0		
18	Bias9 (7.3 mA)	1	х	х	х	1	0	0	1		
19	Bias10 (7.8 mA)	1	х	х	х	1	0	1	0		

<sup>&</sup>lt;sup>1</sup>Target bias mode for Gain modes G2-G5 <sup>2</sup>Target bias mode for Gain modes G0-G1

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**Application Information** 

# 7 Application Information

## **Pin Configuration and Function**

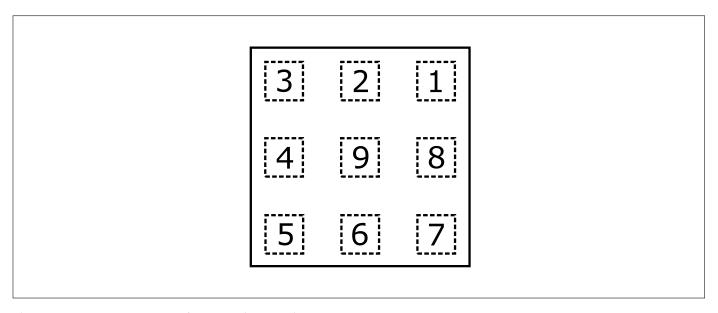


Figure 3: BGA9H1MN9 Pin Configuration (top view)

**Table 15: Pin Definition and Function** 

Pin No.	Name	Function
1	AO	LNA output
2	GND	Ground
3	Al	LNA input
4	USID	USID select pin
5	VIO	MIPI RFFE supply
6	SCLK	MIPI RFFE clock
7	SDATA	MIPI RFFE data
8	VDD	Power supply
9	GND	Ground

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



**Application Information** 

## **Application Board Configuration**

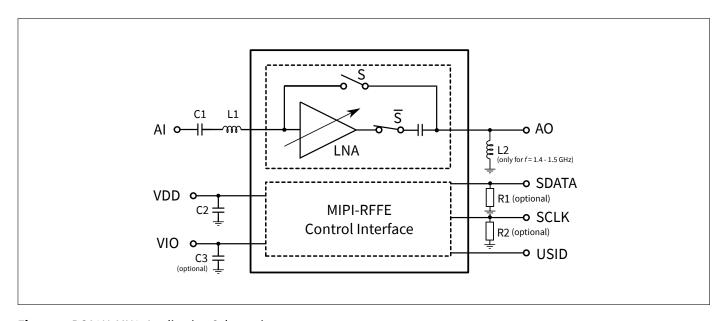


Figure 4: BGA9H1MN9 Application Schematic

**Table 16: Bill of Materials Table** 

Name	Value	Package	Manufacturer	Function		
C1	22 pF	0201	Various	DC block		
C2	10 nF	0201	Various	RF bypass <sup>1</sup>		
C3 (optional)	10 nF	0201	Various	RF bypass <sup>1</sup>		
	11 nH	0201	muRata LQP type	Input matching ( $f = 1.4 - 1.5 \text{ GHz}$ )		
L1	5.6 nH	0201	muRata LQP type	Input matching ( $f = 1.8 - 2.2 \text{ GHz}$ )		
	4.2 nH	0201	muRata LQP type	Input matching ( $f = 2.3 - 2.7 \text{ GHz}$ )		
L2	4 nH	0201	muRata LQP type	Output matching		
R1 (optional)	100 kΩ	0201	Various	Pull-down resistor <sup>2</sup>		
R2 (optional)	100 kΩ	0201	Various	Pull-down resistor <sup>2</sup>		
N1	BGA9H1MN9	TSNP-9-2	Infineon	Variable gainstep LNA		

<sup>&</sup>lt;sup>1</sup>RF bypass recommended to mitigate power supply noise.

<sup>&</sup>lt;sup>2</sup>External pulldown may be required if master doesn't provide proper pulldown before first SSC.



Package Information

# **8 Package Information**

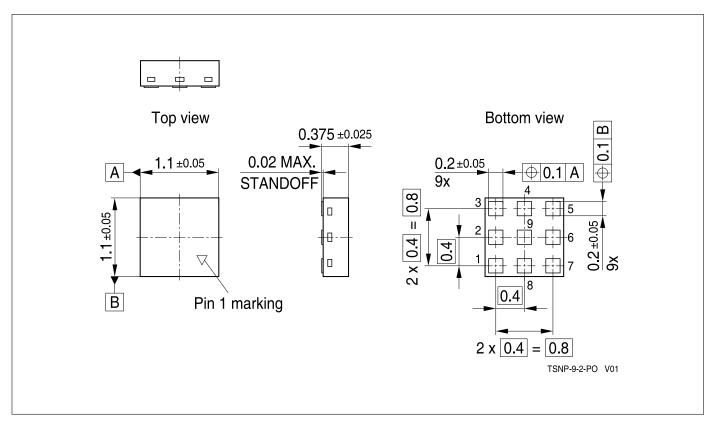


Figure 5: TSNP-9-2 Package Outline (top, side and bottom views)

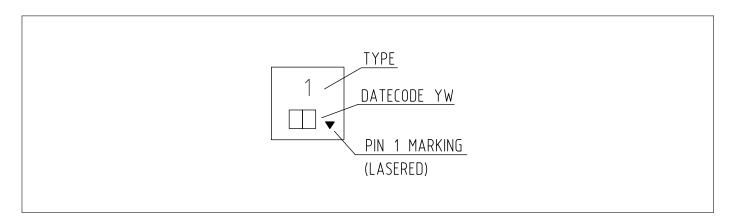


Figure 6: Marking Specification (top view)





Package Information

Table 17: Year date code marking - digit "Y"

Year	"Y"	Year	"Y"	Year	"Y"
2010	0	2020	0	2030	0
2011	1	2021	1	2031	1
2012	2	2022	2	2032	2
2013	3	2023	3	2033	3
2014	4	2024	4	2034	4
2015	5	2025	5	2035	5
2016	6	2026	6	2036	6
2017	7	2027	7	2037	7
2018	8	2028	8	2038	8
2019	9	2029	9	2039	9

Table 18: Week date code marking - digit "W"

Week	"W"	Week	"W"	Week	"W"	Week	"W"	Week	"W"
1	Α	12	N	23	4	34	h	45	V
2	В	13	Р	24	5	35	j	46	x
3	С	14	Q	25	6	36	k	47	у
4	D	15	R	26	7	37	l	48	z
5	E	16	S	27	a	38	n	49	8
6	F	17	Т	28	b	39	р	50	9
7	G	18	U	29	С	40	q	51	2
8	Н	19	V	30	d	41	r	52	3
9	J	20	W	31	e	42	s	53	М
10	K	21	Υ	32	f	43	t		
11	L	22	Z	33	g	44	u		

## Mid- and High-Band Low Noise Amplifier with Gain Steps and MIPI Control



### Package Information

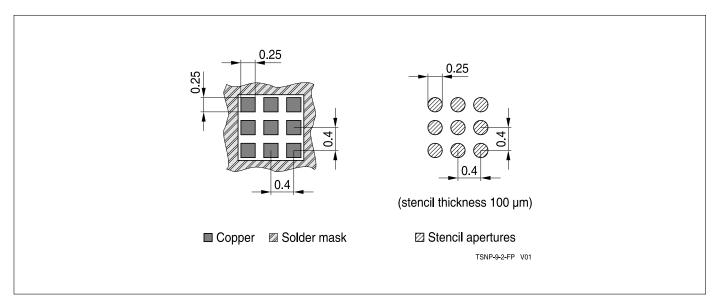


Figure 7: TSNP-9-2 Footprint Recommendation

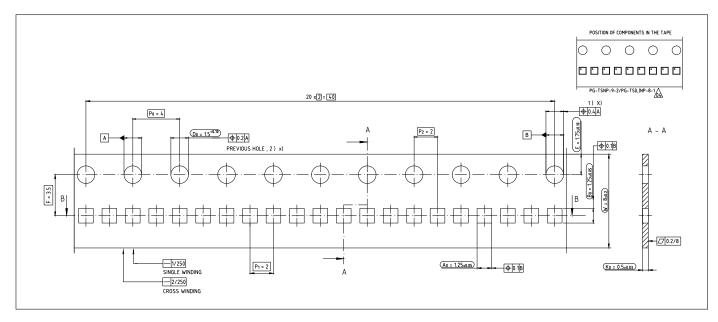


Figure 8: TSNP-9-2 Carrier Tape

Revision History						
Page or Item Subjects (major changes since previous revision)						
Revision 2.0, 2021-0	5-06					
all Initial version of final datasheet						

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